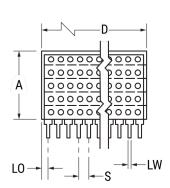


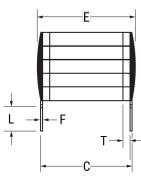
T49470R01685KCN

Aliases (L1RN302685KT36)

KPS LDD Mil SMPS PRF49470, Ceramic, 6.8 uF, 10%, 200 VDC, BR, N/A



Side View



End View

Click here for the 3D model.

Dimensions	
D	25.715mm +/-1.585mm
L	6.35mm MIN
Т	1.397mm MAX
S	2.54mm TYP
F	0.254mm +/-0.051mm
А	9.144mm MAX
С	11.43mm +/-0.635mm
E	12.7mm MAX
G	1.4mm +/-0.25mm
LO	1.586mm MAX
LW	0.508mm +/-0.051mm

Packaging Specifications			
Packaging	Waffle, Box		
Packaging Quantity	28		

General Information	
Series	KPS LDD Mil SMPS PRF49470
Style	Leaded Stacked Chip
Description	Low ESR, High Current Stacked Ceramic Chips
Features	Low ESR, High Current
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
Termination	60/40 Solder Coated
Lead	Wire Leads
Failure Rate	N/A
Testing and Reliability	Level T
Qualifications	MIL-PRF-49470
AEC-Q200	No
Notes	Note: Number of chips in stack depends on design. Note: Lead alignment within pin rows shall be within ±.0.13 mm.

Specifications				
Capacitance	6.8 uF			
Capacitance Tolerance	10%			
Voltage DC	200 VDC			
Dielectric Withstanding Voltage	500 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	BR			
Insulation Resistance	147.059 MOhms			

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)